

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

PCN Title:	Addition of UMC/Japan as an Alternate Wafer Fab Source for MAX98388 and MAX98389 Devices
Publication Date:	18-Jun-2024
Effectivity Date:	16-Sep-2024 (the earliest date that a customer could expect to receive changed material)
Revision Description:	Initial Release.

Description Of Change:

Analog Devices is adding UMC/Japan as an alternate wafer fab site to UMC/Taiwan.

New "DEV_REV" stored in register address (for UMC/Japan Fab):

0x22FF(0x42)

Reason For Change:

This change will ensure manufacturing agility and continuity of supply.

Impact of the change (positive or negative) on fit, form, function & reliability:

There is no impact to fit, form, function, quality, or reliability.

Product Identification (this section will describe how to identify the changed material):

Analog Devices maintains full traceability by device marking, packaging labels and shipment documents.

Summary of Supporting Information:

Qualification has been performed per Industry Standard Test Methods. See attached Qualification Results Summary.

Supporting Documents:

Attachment 1: Type: Qualification Report Summary

[RQR44574B.pdf](#)

ADI Contact Information:

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:	Europe:	Japan:	Korea:	Rest of Asia:
PCN_Americas@analog.com	PCN_Europe@analog.com	PCN_Japan@analog.com	PCN_Korea@analog.com	PCN_ROA@analog.com

Appendix A - Impacted items, see csv PN listing in PCN Zip file